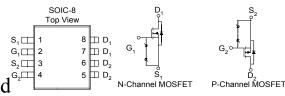
## P & N-Channel 32-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low  $r_{DS(on)}$  and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

PRODUCT SUMMARY						
$V_{DS}(V)$	$r_{DS(on)} m(\Omega)$	$I_{D}(A)$				
30	82	4.2				
	$50 @ V_{GS} = 10V$	5.3				
-30	$80 @ V_{GS} = -4.5V$	-4.2				
	52 @ V <sub>GS</sub> = -10V	-5.2				

 Low r<sub>DS(on)</sub> provides higher efficiency and extends battery life

Low thermal impedance copper leadframe SOIC-8 saves board space ESD Protected



Fast switching speed

High performance trench technology

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	N-Channel	P-Channel	Units	
Drain-Source Voltage		$V_{DS}$	30	-30	V	
Gate-Source Voltage		$V_{GS}$	±20	±20	v	
Continuous Drain Current <sup>a</sup>	$T_A=25^{\circ}C$	Ι_	5.3	-5.2		
Continuous Drain Current	$T_A=25^{\circ}C$ $T_A=70^{\circ}C$	1D	4.2	-4.1	A	
Pulsed Drain Current <sup>b</sup>			20	-20		
Continuous Source Current (Diode Conduction) <sup>a</sup>			1.3	-1.3	A	
D : a	T <sub>A</sub> =25°C	D	2.1	2.1	W	
Power Dissipation <sup>a</sup>	$T_A=70^{\circ}C$	ГD	1.3	1.3	VV	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	-55 to 150		°C	

2000V

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Maximum	Units				
Manimum Lunation to Ambient <sup>a</sup>	t <= 10 sec	D	62.5	°C/W			
Maximum Junction-to-Ambient <sup>a</sup>	Steady-State	$R_{ heta JA}$	110	°C/W			

1

## Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

SPECIFICATIONS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	<b>Test Conditions</b>	Ch	Min	Typ	Max	Unit
Static			-		- J P		
C . Tl 1 11 V I	N/	$V_{GS} = V_{DS}$ , $I_D = 250 \text{ uA}$	N	1.2			.,
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}$ , $I_D = -250 \text{ uA}$	P	-1.2		-2.5	V
Gate-Body Leakage	$I_{GSS}$	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	P			±100	пA
	033	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$	N P			±100	11/1
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$	N			1	uA
On-State Drain Current <sup>A</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	N	20			Α
On-State Drain Current	<sup>1</sup> D(on)	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	P	-20			Α
	l	VGS = 10  V, ID = 5.3  A	N			50	
Drain-Source On-Resistance <sup>A</sup>	r <sub>DS(on)</sub>	VGS = 4.5 V, ID = 4.2 A		<del>-                                    </del>	82 52	mΩ	
	*** /	VGS = -10 V, ID = -5.2 A VGS = -4.5 V, ID = -42 A	P			80	
D : 0 D: 1 E 1W !	V	$V_{GS} = 0 \text{ V}, I_S = 1.3 \text{ A}$	N		0.75		V
Drain-Source Diode Forward Voltage	$V_{\mathrm{SD}}$	$V_{GS} = 0 \text{ V}, I_S = -1.3 \text{ A}$	P		-0.88		· ·
Dynamic							
Total Gate Charge	$Q_{g}$		N		2.2		
Total Gate Charge	≺g	N-Channel	P		10		i
Gate-Source Charge	$Q_{gs}$	$V_{DS}=15V, V_{GS}=10V, I_{D}=5.3A$	N P		0.5		пC
<u> </u>	Voc- 15V Voc- 10V In- 5 24 N		0.8		1		
Gate-Drain Charge	$Q_{gd}$	VDS13 V, VGS10 V, ID3.2A	P		1.7		1
T On Dalan Time	t .		N		8		
Turn-On Delay Time	$t_{d(on)}$	N-Chaneel	P		10		i
Rise Time	$t_{\rm r}$	$V_{DD}=15V, V_{GS}=10V, I_{D}=1A$ ,	N		5		
	,	$R_{\text{GEN}}=6\Omega,$ P-Channel	P N		2.8		nS
Turn-Off Delay Time	$t_{d(off)}$	V <sub>DD</sub> =-15V, V <sub>GS</sub> =-10V, I <sub>D</sub> =-1A	P		53.6		
E II T.	<del>                                     </del>	$R_{GEN}=6\Omega$	N		3		1
Fall-Time	$t_{\mathrm{f}}$	1000	P		46		ĺ

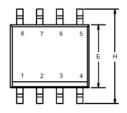
## Notes

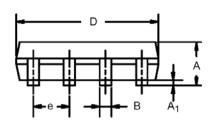
- a. Pulse test:  $PW \le 300us duty cycle \le 2\%$ .
- b. Guaranteed by design, not subject to production testing.

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## Package Information

SO-8: 8LEAD





	MILLIM	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	

